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Understanding Embedded - DSP (Digital Signal Processors)

Embedded - DSP (Digital Signal Processors) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of Embedded - DSP (Digital Signal Processors)

Details	
Product Status	Active
Type	Fixed Point
Interface	Host Interface, Serial Port
Clock Rate	66MHz
Non-Volatile Memory	External
On-Chip RAM	80kB
Voltage - I/O	3.30V
Voltage - Core	2.50V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-2185mbstz-266

ADSP-2185M* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

DOCUMENTATION

Application Notes

- AN-227: Digital Control System Design with the ADSP-2100 Family
- AN-227: Digital Control System Design with the ADSP-2100 Family
- AN-334: Digital Signal Processing Techniques
- AN-524: ADV601/ADV611 Bin Width Calculation in ADSP-21xx DSP
- EE-06: ADSP-21xx Serial Port Startup Issues
- EE-100: ADSP-218x External Overlay Memory
- EE-102: Mode D and ADSP-218x Pin Compatibility - the FAQs
- EE-103: Performing Level Conversion Between 5v and 3.3v IC's
- EE-104: Setting Up Streams with the VisualDSP Debugger
- EE-11: ADSP-2181 Priority Chain & IDMA Holdoffs
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- EE-12: Interrupts and Programmable Flags on the ADSP-2185/2186
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- EE-124: Booting up the ADSP-2192
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- EE-128: DSP in C++: Calling Assembly Class Member Functions From C++
- EE-129: ADSP-2192 Interprocessor Communication
- EE-130: Making Fast Transition from ADSP-21xx to ADSP-219x
- EE-131: Booting the ADSP-2191/95/96 DSPs
- EE-133: Converting From Legacy Architecture Files To Linker Description Files for the ADSP-218x
- EE-139: Interfacing the ADSP-2191 to an AD7476 via the SPI Port
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- EE-145: SPI Booting of the ADSP-2191 using the Atmel AD25020N on an EZ-KIT Lite Evaluation Board

- EE-146: Implementing a Boot Manager for ADSP-218x Family DSPs
- EE-152: Using Software Overlays with the ADSP-219x and VisualDSP 2.0++
- EE-153: ADSP-2191 Programmable PLL
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- EE-158: ADSP-2181 EZ-Kit Lite IDMA to PC Printer Port Interface
- EE-159: Initializing DSP System & Control Registers From C and C++
- EE-164: Advanced EPROM Boot and No-boot Scenarios with ADSP-219x DSPs
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- EE-17: ADSP-2187L Memory Organization
- EE-18: Choosing and Using FFTs for ADSP-21xx
- EE-188: Using C To Implement Interrupt-Driven Systems On ADSP-219x DSPs
- EE-2: Using ADSP-218x I/O Space
- EE-226: ADSP-2191 DSP Host Port Booting
- EE-227: CAN Configuration Procedure for ADSP-21992 DSPs
- EE-249: Implementing Software Overlays on ADSP-218x DSPs with VisualDSP++®
- EE-32: Language Extensions: Memory Storage Types, ASM & Inline Constructs
- EE-33: Programming The ADSP-21xx Timer In C
- EE-35: Troubleshooting your ADSP-218x EZ-ICE
- EE-356: Emulator and Evaluation Hardware Troubleshooting Guide for CCES Users
- EE-36: ADSP-21xx Interface to the IOM-2 bus
- EE-38: ADSP-2181 IDMA Port - Cycle Steal Timing
- EE-39: Interfacing 5V Flash Memory to an ADSP-218x (Byte Programming Algorithm)
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- EE-5: ADSP-218x Full Memory Mode vs. Host Memory Mode
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- EE-78: BDMA Usage on 100 pin ADSP-218x DSPs Configured for IDMA Use
- EE-79: EPROM Booting In Host Mode with 100 Pin 218x Processors
- EE-82: Using an ADSP-2181 DSP's IO Space to IDMA Boot Another ADSP-2181
- EE-89: Implementing A Software UART on the ADSP-2181 EZ-Kit-Lite
- EE-90: Using the 21xx C-FFT Library
- EE-96: Interfacing Two AD73311 Codecs to the ADSP-218x

Data Sheet

- ADSP-2185M: 16-bit, 75 MIPS, 2.5v, 2 serial ports, host port, 80 KB RAM Data Sheet

Integrated Circuit Anomalies

- ADSP-2185M Anomaly List for Revision 2.1

Processor Manuals

- ADSP 21xx Processors: Manuals
- ADSP-218x DSP Hardware Reference
- ADSP-218x DSP Instruction Set Reference
- Using the ADSP-2100 Family Volume 2

Software Manuals

- VisualDSP++ 3.5 Assembler and Preprocessor Manual for ADSP-218x and ADSP-219x DSPs
- VisualDSP++ 3.5 C Compiler and Library Manual for ADSP-218x DSPs
- VisualDSP++ 3.5 C/C++ Compiler and Library Manual for ADSP-219x Processors
- VisualDSP++ 3.5 Linker and Utilities Manual for 16-Bit Processors
- VisualDSP++ 3.5 Loader Manual for 16-Bit Processors

SOFTWARE AND SYSTEMS REQUIREMENTS

- Software and Tools Anomalies Search

TOOLS AND SIMULATIONS

- ADSP-218xM IBIS Datafile (LQFP Package)

REFERENCE MATERIALS

Product Selection Guide

- ADI Complementary Parts Guide - Supervisory Devices and DSP Processors

GENERAL DESCRIPTION

The ADSP-2185M is a single-chip microcomputer optimized for digital signal processing (DSP) and other high-speed numeric processing applications.

The ADSP-2185M combines the ADSP-2100 family base architecture (three computational units, data address generators, and a program sequencer) with two serial ports, a 16-bit internal DMA port, a byte DMA port, a programmable timer, Flag I/O, extensive interrupt capabilities, and on-chip program and data memory.

The ADSP-2185M integrates 80K bytes of on-chip memory configured as 16K words (24-bit) of program RAM, and 16K words (16-bit) of data RAM. Power-down circuitry is also provided to meet the low power needs of battery-operated portable equipment. The ADSP-2185M is available in a 100-lead LQFP package and 144 Ball Mini-BGA.

In addition, the ADSP-2185M supports new instructions, which include bit manipulations—bit set, bit clear, bit toggle, bit test—new ALU constants, new multiplication instruction (× squared), biased rounding, result-free ALU operations, I/O memory transfers, and global interrupt masking, for increased flexibility.

Fabricated in a high-speed, low-power, CMOS process, the ADSP-2185M operates with a 13.3 ns instruction cycle time. Every instruction can execute in a single processor cycle.

The ADSP-2185M's flexible architecture and comprehensive instruction set allow the processor to perform multiple operations in parallel. In one processor cycle, the ADSP-2185M can:

- Generate the next program address
- Fetch the next instruction
- Perform one or two data moves
- Update one or two data address pointers
- Perform a computational operation

This takes place while the processor continues to:

- Receive and transmit data through the two serial ports
- Receive and/or transmit data through the internal DMA port
- Receive and/or transmit data through the byte DMA port
- Decrement timer

DEVELOPMENT SYSTEM

The ADSP-2100 Family Development Software, a complete set of tools for software and hardware system development, supports the ADSP-2185M. The System Builder provides a high-level method for defining the architecture of systems under development. The Assembler has an algebraic syntax that is easy to program and debug. The Linker combines object files into an executable file. The Simulator provides an interactive instruction-level simulation with a reconfigurable user interface to display different portions of the hardware environment.

The EZ-KIT Lite is a hardware/software kit offering a complete evaluation environment for the ADSP-218x family: an ADSP-2189M-based evaluation board with PC monitor software plus assembler, linker, simulator, and PROM splitter software. The ADSP-2189M EZ-KIT Lite is a low cost, easy to use hardware platform on which you can quickly get started with your DSP software design. The EZ-KIT Lite includes the following features:

- 75 MHz ADSP-2189M
- Full 16-Bit Stereo Audio I/O with AD73322 Codec
- RS-232 Interface
- EZ-ICE Connector for Emulator Control
- DSP Demo Programs
- Evaluation Suite of VisualDSP

The ADSP-218x EZ-ICE® Emulator aids in the hardware debugging of an ADSP-2185M system. The ADSP-2185M integrates on-chip emulation support with a 14-pin ICE-Port interface. This interface provides a simpler target board connection that requires fewer mechanical clearance considerations than other ADSP-2100 Family EZ-ICEs. The ADSP-2185M device need not be removed from the target system when using the EZ-ICE, nor are any adapters needed. Due to the small footprint of the EZ-ICE connector, emulation can be supported in final board designs.

The EZ-ICE performs a full range of functions, including:

- In-target operation
- Up to 20 breakpoints
- Single-step or full-speed operation
- Registers and memory values can be examined and altered
- PC upload and download functions
- Instruction-level emulation of program booting and execution
- Complete assembly and disassembly of instructions
- C source-level debugging

See *Designing An EZ-ICE-Compatible Target System* in the *ADSP-2100 Family EZ-Tools Manual* (ADSP-2181 sections) as well as the Designing an EZ-ICE-Compatible System section of this data sheet for the exact specifications of the EZ-ICE target board connector.

Additional Information

This data sheet provides a general overview of ADSP-2185M functionality. For additional information on the architecture and instruction set of the processor, refer to the *ADSP-2100 Family User's Manual*. For more information about the development tools, refer to the ADSP-2100 Family Development Tools data sheet.

EZ-ICE is a registered trademark of Analog Devices, Inc.

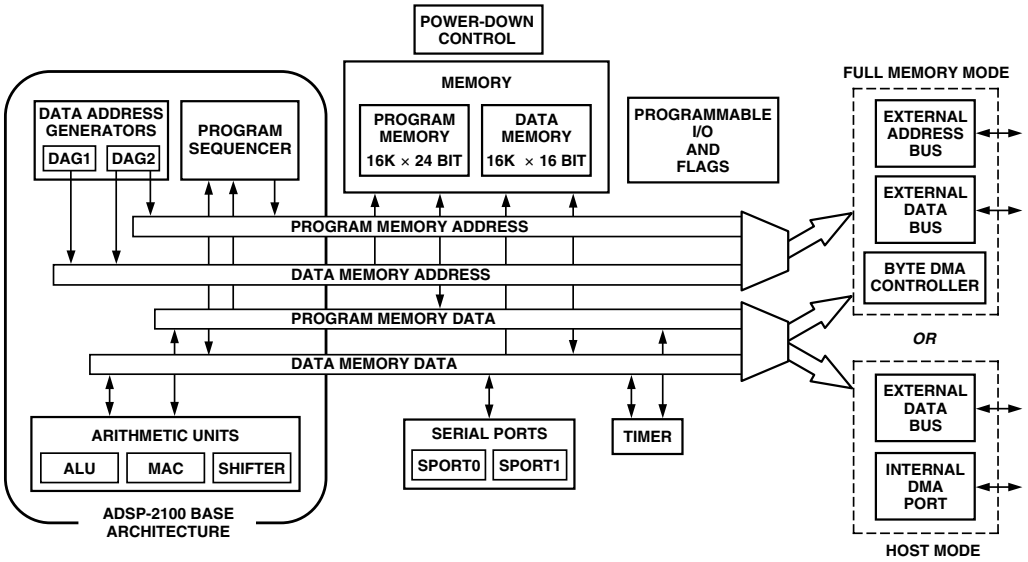


Figure 1. Functional Block Diagram

ARCHITECTURE OVERVIEW

The ADSP-2185M instruction set provides flexible data moves and multifunction (one or two data moves with a computation) instructions. Every instruction can be executed in a single processor cycle. The ADSP-2185M assembly language uses an algebraic syntax for ease of coding and readability. A comprehensive set of development tools supports program development.

Figure 1 is an overall block diagram of the ADSP-2185M. The processor contains three independent computational units: the ALU, the multiplier/accumulator (MAC), and the shifter. The computational units process 16-bit data directly and have provisions to support multiprecision computations. The ALU performs a standard set of arithmetic and logic operations; division primitives are also supported. The MAC performs single-cycle multiply, multiply/add, and multiply/subtract operations with 40 bits of accumulation. The shifter performs logical and arithmetic shifts, normalization, denormalization, and derive exponent operations.

The shifter can be used to efficiently implement numeric format control, including multiword and block floating-point representations.

The internal result (R) bus connects the computational units so that the output of any unit may be the input of any unit on the next cycle.

A powerful program sequencer and two dedicated data address generators ensure efficient delivery of operands to these computational units. The sequencer supports conditional jumps, subroutine calls, and returns in a single cycle. With internal loop counters and loop stacks, the ADSP-2185M executes looped code with zero overhead; no explicit jump instructions are required to maintain loops.

Two data address generators (DAGs) provide addresses for simultaneous dual operand fetches (from data memory and program memory). Each DAG maintains and updates four address pointers. Whenever the pointer is used to access data (indirect addressing), it is post-modified by the value of one of four possible modify registers. A length value may be associated with each pointer to implement automatic modulo addressing for circular buffers.

Efficient data transfer is achieved with the use of five internal buses:

- Program Memory Address (PMA) Bus
- Program Memory Data (PMD) Bus
- Data Memory Address (DMA) Bus
- Data Memory Data (DMD) Bus
- Result (R) Bus

The two address buses (PMA and DMA) share a single external address bus, allowing memory to be expanded off-chip, and the two data buses (PMD and DMD) share a single external data bus. Byte memory space and I/O memory space also share the external buses.

Program memory can store both instructions and data, permitting the ADSP-2185M to fetch two operands in a single cycle, one from program memory and one from data memory. The ADSP-2185M can fetch an operand from program memory and the next instruction in the same cycle.

In lieu of the address and data bus for external memory connection, the ADSP-2185M may be configured for 16-bit Internal DMA port (IDMA port) connection to external systems. The IDMA port is made up of 16 data/address pins and five control pins. The IDMA port provides transparent, direct access to the DSPs on-chip program and data RAM.

An interface to low-cost byte-wide memory is provided by the Byte DMA port (BDMA port). The BDMA port is bidirectional and can directly address up to four megabytes of external RAM or ROM for off-chip storage of program overlays or data tables.

The byte memory and I/O memory space interface supports slow memories and I/O memory-mapped peripherals with programmable wait state generation. External devices can gain control of

Memory Interface Pins

The ADSP-2185M processor can be used in one of two modes: Full Memory Mode, which allows BDMA operation with full external overlay memory and I/O capability, or Host Mode, which allows IDMA operation with limited external addressing capabilities. The operating mode is determined by the state of the Mode C pin during $\overline{\text{RESET}}$ and cannot be changed while the processor is running.

The following tables list the active signals at specific pins of the DSP during either of the two operating modes (Full Memory or Host). A signal in one table shares a pin with a signal from the other table, with the active signal determined by the mode set. For the shared pins and their alternate signals (e.g., A4/IAD3), refer to the package pinout tables.

Full Memory Mode Pins (Mode C = 0)

Pin Name	# of Pins	I/O	Function
A13:0	14	O	Address Output Pins for Program, Data, Byte, and I/O Spaces
D23:0	24	I/O	Data I/O Pins for Program, Data, Byte, and I/O Spaces (8 MSBs are also used as Byte Memory Addresses.)

Host Mode Pins (Mode C = 1)

Pin Name	# of Pins	I/O	Function
IAD15:0	16	I/O	IDMA Port Address/Data Bus
A0	1	O	Address Pin for External I/O, Program, Data, or Byte Access[1]
D23:8	16	I/O	Data I/O Pins for Program, Data, Byte, and I/O Spaces
$\overline{\text{IWR}}$	1	I	IDMA Write Enable
$\overline{\text{IRD}}$	1	I	IDMA Read Enable
IAL	1	I	IDMA Address Latch Pin
$\overline{\text{IS}}$	1	I	IDMA Select
$\overline{\text{IACK}}$	1	O	IDMA Port Acknowledge Configurable in Mode D; Open Drain

NOTE

[1]In Host Mode, external peripheral addresses can be decoded using the A0, $\overline{\text{CMS}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, and $\overline{\text{IOMS}}$ signals.

Slow Idle
The IDLE instruction is enhanced on the ADSP-2185M to let the processor's internal clock signal be slowed, further reducing power consumption. The reduced clock frequency, a programmable fraction of the normal clock rate, is specified by a selectable divisor given in the IDLE instruction.

The format of the instruction is:

IDLE (n);

where *n* = 16, 32, 64, or 128. This instruction keeps the processor fully functional, but operating at the slower clock rate. While it is in this state, the processor's other internal clock signals, such as SCLK, CLKOUT, and timer clock, are reduced by the same ratio. The default form of the instruction, when no clock divisor is given, is the standard IDLE instruction.

When the IDLE (n) instruction is used, it effectively slows down the processor's internal clock and thus its response time to incoming interrupts. The one-cycle response time of the standard idle state is increased by n, the clock divisor. When an enabled interrupt is received, the ADSP-2185M will remain in the idle state for up to a maximum of n processor cycles (n = 16, 32, 64, or 128) before resuming normal operation.

When the IDLE (n) instruction is used in systems that have an externally generated serial clock (SCLK), the serial clock rate may be faster than the processor's reduced internal clock rate. Under these conditions, interrupts must not be generated at a faster than can be serviced, due to the additional time the processor takes to come out of the idle state (a maximum of n processor cycles).

SYSTEM INTERFACE
Figure 2 shows typical basic system configurations with the ADSP-2185M, two serial devices, a byte-wide EPROM, and optional external program and data overlay memories (mode-selectable). Programmable wait state generation allows the processor to connect easily to slow peripheral devices. The ADSP-2185M also provides four external interrupts and two serial ports or six external interrupts and one serial port. Host Memory Mode allows access to the full external data bus, but limits addressing to a single address bit (A0). Through the use of external hardware, additional system peripherals can be added in this mode to generate and latch address signals.

Clock Signals
The ADSP-2185M can be clocked by either a crystal or a TTL-compatible clock signal.

The CLKIN input cannot be halted, changed during operation, nor operated below the specified frequency during normal operation. The only exception is while the processor is in the power-down state. For additional information, refer to Chapter 9, *ADSP-2100 Family User's Manual,* for detailed information on this power-down feature.

If an external clock is used, it should be a TTL-compatible signal running at half the instruction rate. The signal is connected to the processor's CLKIN input. When an external clock is used, the XTAL input must be left unconnected.

The ADSP-2185M uses an input clock with a frequency equal to half the instruction rate; a 37.50 MHz input clock yields a 13 ns processor cycle (which is equivalent to 75 MHz). Normally, instructions are executed in a single processor cycle. All device timing is relative to the internal instruction clock rate, which is indicated by the CLKOUT signal when enabled.

Because the ADSP-2185M includes an on-chip oscillator circuit, an external crystal may be used. The crystal should be connected across the CLKIN and XTAL pins, with two capacitors connected as shown in Figure 3. Capacitor values are dependent on crystal type and should be specified by the crystal manufacturer. A parallel-resonant, fundamental frequency, microprocessor-grade crystal should be used.

A clock output (CLKOUT) signal is generated by the processor at the processor's cycle rate. This can be enabled and disabled by the CLKODIS bit in the SPORT0 Autobuffer Control Register.

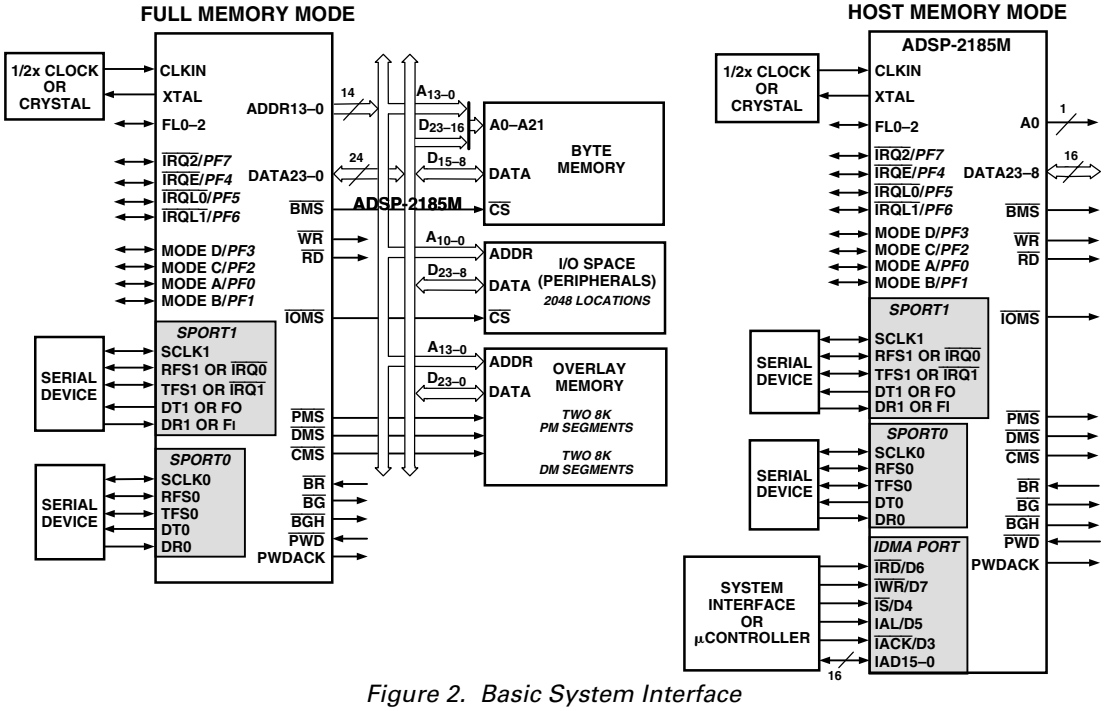


Figure 2. Basic System Interface

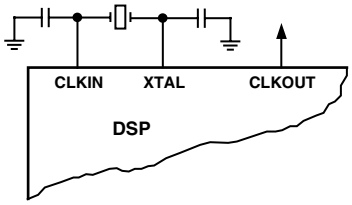


Figure 3. External Crystal Connections

RESET

The RESET signal initiates a master reset of the ADSP-2185M. The RESET signal must be asserted during the power-up sequence to assure proper initialization. RESET during initial power-up must be held long enough to allow the internal clock to stabilize. If RESET is activated any time after power-up, the clock continues to run and does not require stabilization time.

The power-up sequence is defined as the total time required for the crystal oscillator circuit to stabilize after a valid V_{DD} is applied to the processor, and for the internal phase-locked loop (PLL) to lock onto the specific crystal frequency. A minimum of 2000 CLKIN cycles ensures that the PLL has locked but does not include the crystal oscillator start-up time. During this power-up sequence the RESET signal should be held low. On any subsequent resets, the RESET signal must meet the minimum pulsewidth specification, t_{RSP}.

The RESET input contains some hysteresis; however, if an RC circuit is used to generate the RESET signal, the use of an external Schmidt trigger is recommended.

The master reset sets all internal stack pointers to the empty stack condition, masks all interrupts, and clears the MSTAT register. When RESET is released, if there is no pending bus request and the chip is configured for booting, the boot-loading sequence is performed. The first instruction is fetched from on-chip program memory location 0x0000 once boot loading completes.

Power Supplies

The ADSP-2185M has separate power supply connections for the internal (V_{DDINT}) and external (V_{DDEXT}) power supplies. The internal supply must meet the 2.5 V requirement. The external supply can be connected to either a 2.5 V or 3.3 V supply. All external supply pins must be connected to the same supply. All input and I/O pins can tolerate input voltages up to 3.6 V, regardless of the external supply voltage. This feature provides maximum flexibility in mixing 2.5 V and 3.3 V components.

MODES OF OPERATION

Setting Memory Mode

Memory Mode selection for the ADSP-2185M is made during chip reset through the use of the Mode C pin. This pin is multiplexed with the DSP's PF2 pin, so care must be taken in how the mode selection is made. The two methods for selecting the value of Mode C are active and passive.

Passive Configuration

Passive Configuration involves the use a pull-up or pull-down resistor connected to the Mode C pin. To minimize power consumption, or if the PF2 pin is to be used as an output in the DSP application, a weak pull-up or pull-down, on the order of 10 kΩ, can be used. This value should be sufficient to pull the pin to the desired level and still allow the pin to operate as a programmable flag output without undue strain on the processor's output driver. For minimum power consumption during power-down, reconfigure PF2 to be an input, as the pull-up or pull-down will hold the pin in a known state, and will not switch.

Table II. Modes of Operation

MODE D	MODE C	MODE B	MODE A	Booting Method
X	0	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Full Memory Mode.[1]
X	0	1	0	No automatic boot operations occur. Program execution starts at external memory location 0. Chip is configured in Full Memory Mode. BDMA can still be used, but the processor does not automatically use or wait for these operations.
0	1	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Host Mode. IACK has active pull-down. (REQUIRES ADDITIONAL HARDWARE).
0	1	0	1	IDMA feature is used to load any internal memory as desired. Program execution is held off until internal program memory location 0 is written to. Chip is configured in Host Mode. IACK has active pull-down.[1]
1	1	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Host Mode; IACK requires external pull down. (REQUIRES ADDITIONAL HARDWARE)
1	1	0	1	IDMA feature is used to load any internal memory as desired. Program execution is held off until internal program memory location 0 is written to. Chip is configured in Host Mode. IACK requires external pull-down.[1]

NOTE
[1]Considered as standard operating settings. Using these configurations allows for easier design and better memory management.

Active Configuration
Active Configuration involves the use of a three-statable external driver connected to the Mode C pin. A driver's output enable should be connected to the DSP's $\overline{\text{RESET}}$ signal such that it only drives the PF2 pin when $\overline{\text{RESET}}$ is active (low). When $\overline{\text{RESET}}$ is deasserted, the driver should three-state, thus allowing full use of the PF2 pin as either an input or output. To minimize power consumption during power-down, configure the programmable flag as an output when connected to a three-stated buffer. This ensures that the pin will be held at a constant level, and will not oscillate should the three-state driver's level hover around the logic switching point.

$\overline{\text{IACK}}$ Configuration
Mode D = 0 and in host mode: $\overline{\text{IACK}}$ is an active, driven signal and cannot be "wire OR'd."

Mode D = 1 and in host mode: $\overline{\text{IACK}}$ is an open drain and requires an external pull-down, but multiple $\overline{\text{IACK}}$ pins can be "wire OR'd" together.

MEMORY ARCHITECTURE
The ADSP-2185M provides a variety of memory and peripheral interface options. The key functional groups are Program Memory, Data Memory, Byte Memory, and I/O. Refer to the following figures and tables for PM and DM memory allocations in the ADSP-2185M.

Program Memory
Program Memory (Full Memory Mode) is a 24-bit-wide space for storing both instruction opcodes and data. The ADSP-2185M has 16K words of Program Memory RAM on chip, and the capability of accessing up to two 8K external memory overlay spaces using the external data bus.

Program Memory (Host Mode) allows access to all internal memory. External overlay access is limited by a single external address line (A0). External program execution is not available in host mode due to a restricted data bus that is 16 bits wide only.

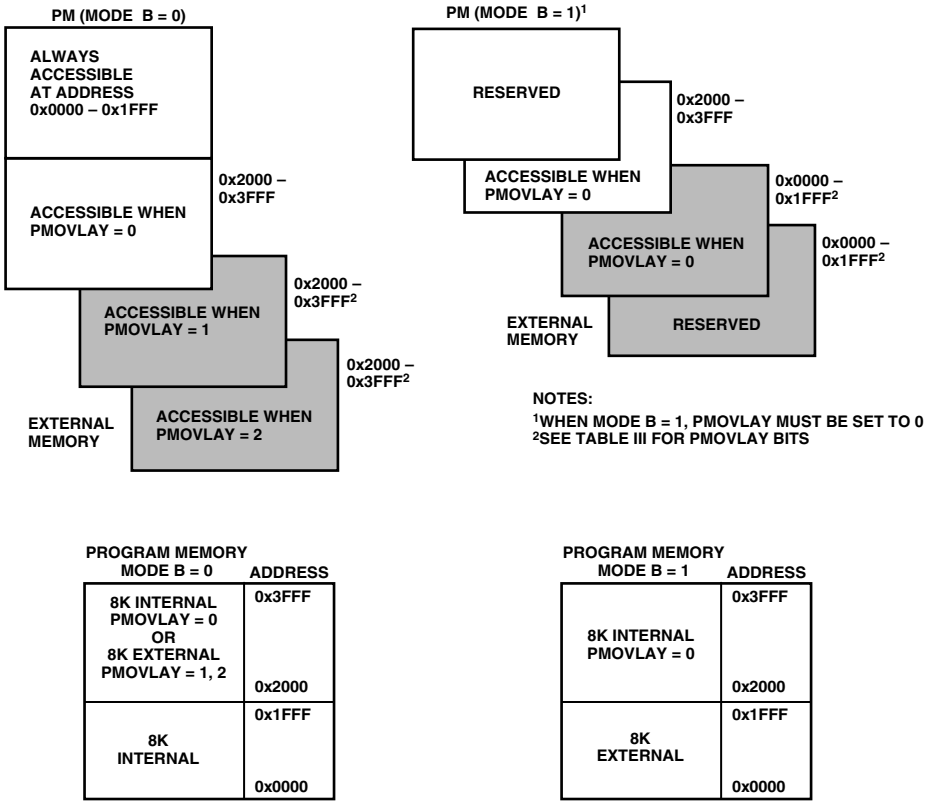


Figure 4. Program Memory

Table III. PMOVLAY Bits

PMOVLAY	Memory	A13	A12:0
0	Internal	Not Applicable	Not Applicable
1	External Overlay 1	0	13 LSBs of Address Between 0x2000 and 0x3FFF
2	External Overlay 2	1	13 LSBs of Address Between 0x2000 and 0x3FFF

Table V. Wait States

Address Range	Wait State Register
0x000–0x1FF	IOWAIT0 and Wait State Mode Select Bit
0x200–0x3FF	IOWAIT1 and Wait State Mode Select Bit
0x400–0x5FF	IOWAIT2 and Wait State Mode Select Bit
0x600–0x7FF	IOWAIT3 and Wait State Mode Select Bit

Composite Memory Select ($\overline{\text{CMS}}$)
The ADSP-2185M has a programmable memory select signal that is useful for generating memory select signals for memories mapped to more than one space. The $\overline{\text{CMS}}$ signal is generated to have the same timing as each of the individual memory select signals ($\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$) but can combine their functionality.

Each bit in the CMSSEL register, when set, causes the $\overline{\text{CMS}}$ signal to be asserted when the selected memory select is asserted. For example, to use a 32K word memory to act as both program and data memory, set the $\overline{\text{PMS}}$ and $\overline{\text{DMS}}$ bits in the CMSSEL register and use the $\overline{\text{CMS}}$ pin to drive the chip select of the memory, and use either $\overline{\text{DMS}}$ or $\overline{\text{PMS}}$ as the additional address bit.

The $\overline{\text{CMS}}$ pin functions like the other memory select signals with the same timing and bus request logic. A 1 in the enable bit causes the assertion of the $\overline{\text{CMS}}$ signal at the same time as the selected memory select signal. All enable bits default to 1 at reset, except the $\overline{\text{BMS}}$ bit.

Byte Memory Select ($\overline{\text{BMS}}$)
The ADSP-2185M's $\overline{\text{BMS}}$ disable feature combined with the $\overline{\text{CMS}}$ pin allows use of multiple memories in the byte memory space. For example, an EPROM could be attached to the $\overline{\text{BMS}}$ select, and an SRAM could be connected to $\overline{\text{CMS}}$. Because at reset $\overline{\text{BMS}}$ is enabled, the EPROM would be used for booting. After booting, software could disable $\overline{\text{BMS}}$ and set the $\overline{\text{CMS}}$ signal to respond to $\overline{\text{BMS}}$, enabling the SRAM.

Byte Memory
The byte memory space is a bidirectional, 8-bit-wide, external memory space used to store programs and data. Byte memory is accessed using the BDMA feature. The byte memory space consists of 256 pages, each of which is 16K × 8.

The byte memory space on the ADSP-2185M supports read and write operations as well as four different data formats. The byte memory uses data bits 15:8 for data. The byte memory uses data bits 23:16 and address bits 13:0 to create a 22-bit address. This allows up to a 4 meg × 8 (32 megabit) ROM or RAM to be used without glue logic. All byte memory accesses are timed by the BMWAIT register and the wait state mode bit.

Byte Memory DMA (BDMA, Full Memory Mode)
The byte memory DMA controller allows loading and storing of program instructions and data using the byte memory space. The BDMA circuit is able to access the byte memory space while the processor is operating normally and steals only one DSP cycle per 8-, 16- or 24-bit word transferred.

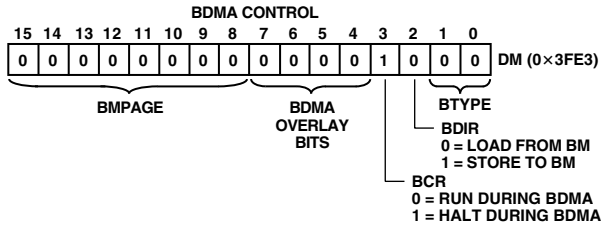


Figure 9. BDMA Control Register

The BDMA circuit supports four different data formats that are selected by the BTYPE register field. The appropriate number of 8-bit accesses are done from the byte memory space to build the word size selected. Table VI shows the data formats supported by the BDMA circuit.

Table VI. Data Formats

BTYPE	Internal Memory Space	Word Size	Alignment
00	Program Memory	24	Full Word
01	Data Memory	16	Full Word
10	Data Memory	8	MSBs
11	Data Memory	8	LSBs

Unused bits in the 8-bit data memory formats are filled with 0s. The BIAD register field is used to specify the starting address for the on-chip memory involved with the transfer. The 14-bit BEAD register specifies the starting address for the external byte memory space. The 8-bit BMPAGE register specifies the starting page for the external byte memory space. The BDIR register field selects the direction of the transfer. Finally, the 14-bit BWCOUNT register specifies the number of DSP words to transfer and initiates the BDMA circuit transfers.

BDMA accesses can cross page boundaries during sequential addressing. A BDMA interrupt is generated on the completion of the number of transfers specified by the BWCOUNT register.

The BWCOUNT register is updated after each transfer so it can be used to check the status of the transfers. When it reaches zero, the transfers have finished and a BDMA interrupt is generated. The BMPAGE and BEAD registers must not be accessed by the DSP during BDMA operations.

The source or destination of a BDMA transfer will always be on-chip program or data memory.

When the BWCOUNT register is written with a nonzero value the BDMA circuit starts executing byte memory accesses with wait states set by BMWAIT. These accesses continue until the count reaches zero. When enough accesses have occurred to create a destination word, it is transferred to or from on-chip memory. The transfer takes one DSP cycle. DSP accesses to external memory have priority over BDMA byte memory accesses.

The BDMA Context Reset bit (BCR) controls whether the processor is held off while the BDMA accesses are occurring. Setting the BCR bit to 0 allows the processor to continue operations. Setting the BCR bit to 1 causes the processor to stop execution while the BDMA accesses are occurring, to clear the context of the processor, and start execution at address 0 when the BDMA accesses have completed.

The BDMA overlay bits specify the OVLAY memory blocks to be accessed for internal memory. For ADSP-2185M, set to zero BDMA overlay bits in BDMA control register.

The BMWAIT field, which has 4 bits on ADSP-2185M, allows selection up to 15 wait states for BDMA transfers.

Internal Memory DMA Port (IDMA Port; Host Memory Mode)

The IDMA Port provides an efficient means of communication between a host system and the ADSP-2185M. The port is used to access the on-chip program memory and data memory of the DSP with only one DSP cycle per word overhead. The IDMA port cannot, however, be used to write to the DSP's memory-mapped control registers. A typical IDMA transfer process is described as follows:

1. Host starts IDMA transfer
2. Host checks $\overline{\text{IACK}}$ control line to see if the DSP is busy
3. Host uses $\overline{\text{IS}}$ and IAL control lines to latch either the DMA starting address (IDMAA) or the PM/DM OVLAY selection into the DSP's IDMA control registers. If Bit 15 = 1, the value of bits 7:0 represent the IDMA overlay: bits 14:8 must be set to 0. If Bit 15 = 0, the value of Bits 13:0 represent the starting address of internal memory to be accessed and Bit 14 reflects PM or DM for access. For ADSP-2185M, IDDMOVLAY and IDPMOVLAY bits in IDMA overlay register should be set to zero.
4. Host uses $\overline{\text{IS}}$ and $\overline{\text{IRD}}$ (or $\overline{\text{IWR}}$) to read (or write) DSP internal memory (PM or DM).
5. Host checks $\overline{\text{IACK}}$ line to see if the DSP has completed the previous IDMA operation.
6. Host ends IDMA transfer.

The IDMA port has a 16-bit multiplexed address and data bus and supports 24-bit program memory. The IDMA port is completely asynchronous and can be written while the ADSP-2185M is operating at full speed.

The DSP memory address is latched and then automatically incremented after each IDMA transaction. An external device can therefore access a block of sequentially addressed memory by specifying only the starting address of the block. This increases throughput as the address does not have to be sent for each memory access.

IDMA Port access occurs in two phases. The first is the IDMA Address Latch cycle. When the acknowledge is asserted, a 14-bit address and 1-bit destination type can be driven onto the bus by an external device. The address specifies an on-chip memory location, the destination type specifies whether it is a DM or PM access. The falling edge of the IDMA address latch signal (IAL) or the missing edge of the IDMA select signal ($\overline{\text{IS}}$) latches this value into the IDMAA register.

Once the address is stored, data can be read from, or written to, the ADSP-2185M's on-chip memory. Asserting the select line ($\overline{\text{IS}}$) and the appropriate read or write line ($\overline{\text{IRD}}$ and $\overline{\text{IWR}}$ respectively) signals the ADSP-2185M that a particular transaction is required. In either case, there is a one-processor-cycle delay for synchronization. The memory access consumes one additional processor cycle.

Once an access has occurred, the latched address is automatically incremented, and another access can occur.

Through the IDMAA register, the DSP can also specify the starting address and data format for DMA operation. Asserting the IDMA port select ($\overline{\text{IS}}$) and address latch enable (IAL) directs the ADSP-2185M to write the address onto the IAD0–14 bus into the IDMA Control Register. If Bit 15 is set to 0, IDMA latches the address. If Bit 15 is set to 1, IDMA latches into the OVLAY register. This register, shown below, is memory mapped at address DM (0x3FE0). Note that the latched address (IDMAA) cannot be read back by the host. When Bit 14 in 0x3FE7 is set to 1, timing in Figure 31 applies for short reads. When Bit 14 in 0x3FE7 is set to zero, short reads use the timing shown in Figure 32. For ADSP-2185M, IDDMOVLAY and IDPMOVLAY bits in IDMA overlay register should be set to zero.

Refer to the following figures for more information on IDMA and DMA memory maps.

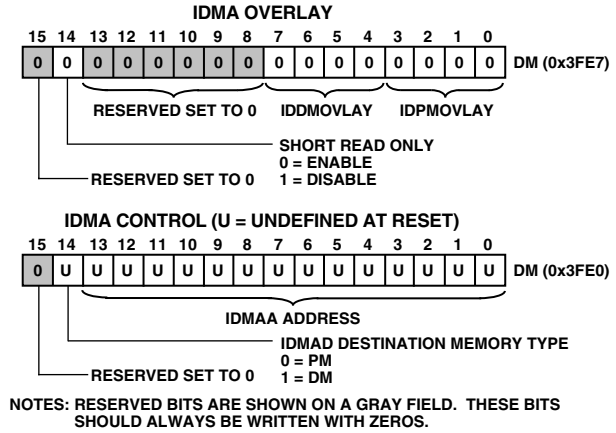
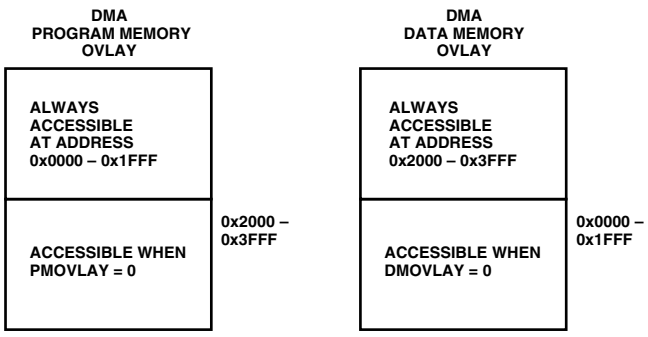


Figure 10. IDMA Control/OVLAY Registers



NOTE: IDMA AND BDMA HAVE SEPARATE DMA CONTROL REGISTERS.

Figure 11. Direct Memory Access—PM and DM Memory Maps

Bootstrap Loading (Booting)

The ADSP-2185M has two mechanisms to allow automatic loading of the internal program memory after reset. The method for booting is controlled by the Mode A, B, and C configuration bits.

When the MODE pins specify BDMA booting, the ADSP-2185M initiates a BDMA boot sequence when reset is released.

The BDMA interface is set up during reset to the following defaults when BDMA booting is specified: the BDIR, BMPAGE, BIAD, and BEAD registers are set to 0, the BTYPE register is set to 0 to specify program memory 24-bit words, and the BWCOUNT register is set to 32. This causes 32 words of on-chip program memory to be loaded from byte memory.

These 32 words are used to set up the BDMA to load in the remaining program code. The BCR bit is also set to 1, which causes program execution to be held off until all 32 words are loaded into on-chip program memory. Execution then begins at address 0.

The ADSP-2100 Family development software (Revision 5.02 and later) fully supports the BDMA booting feature and can generate byte memory space compatible boot code.

The IDLE instruction can also be used to allow the processor to hold off execution while booting continues through the BDMA interface. For BDMA accesses while in Host Mode, the addresses to boot memory must be constructed externally to the ADSP-2185M. The only memory address bit provided by the processor is A0.

IDMA Port Booting
The ADSP-2185M can also boot programs through its Internal DMA port. If Mode C = 1, Mode B = 0, and Mode A = 1, the ADSP-2185M boots from the IDMA port. IDMA feature can load as much on-chip memory as desired. Program execution is held off until on-chip program memory location 0 is written to.

Bus Request and Bus Grant
The ADSP-2185M can relinquish control of the data and address buses to an external device. When the external device requires access to memory, it asserts the bus request ($\overline{BR}$) signal. If the ADSP-2185M is not performing an external memory access, it responds to the active $\overline{BR}$ input in the following processor cycle by:

- Three-stating the data and address buses and the $\overline{PMS}$, $\overline{DMS}$, $\overline{BMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{RD}$, $\overline{WR}$ output drivers,
- Asserting the bus grant ($\overline{BG}$) signal, and
- Halting program execution.

If Go Mode is enabled, the ADSP-2185M will not halt program execution until it encounters an instruction that requires an external memory access.

If the ADSP-2185M is performing an external memory access when the external device asserts the $\overline{BR}$ signal, it will not three-state the memory interfaces nor assert the $\overline{BG}$ signal until the processor cycle after the access completes. The instruction does not need to be completed when the bus is granted. If a single instruction requires two external memory accesses, the bus will be granted between the two accesses.

When the $\overline{BR}$ signal is released, the processor releases the $\overline{BG}$ signal, re-enables the output drivers, and continues program execution from the point at which it stopped.

The bus request feature operates at all times, including when the processor is booting and when $\overline{RESET}$ is active.

The $\overline{BGH}$ pin is asserted when the ADSP-2185M requires the external bus for a memory or BDMA access, but is stopped. The other device can release the bus by deasserting bus request. Once the bus is released, the ADSP-2185M deasserts $\overline{BG}$ and $\overline{BGH}$ and executes the external memory access.

Flag I/O Pins
The ADSP-2185M has eight general purpose programmable input/output flag pins. They are controlled by two memory mapped registers. The PFTYPE register determines the direction, 1 = output and 0 = input. The PFDATA register is used to read and write the values on the pins. Data being read from a pin configured as an input is synchronized to the ADSP-2185M's clock. Bits that are programmed as outputs will read the value being output. The PF pins default to input during reset.

In addition to the programmable flags, the ADSP-2185M has five fixed-mode flags, FI, FO, FL0, FL1, and FL2. FL0–FL2 are dedicated output flags. FI and FO are available as an alternate configuration of SPORT1.

Note: Pins PF0, PF1, PF2, and PF3 are also used for device configuration during reset.

Instruction Set Description
The ADSP-2185M assembly language instruction set has an algebraic syntax that was designed for ease of coding and readability. The assembly language, which takes full advantage of the processor's unique architecture, offers the following benefits:

- The algebraic syntax eliminates the need to remember cryptic assembler mnemonics. For example, a typical arithmetic add instruction, such as AR = AX0 + AY0, resembles a simple equation.
- Every instruction assembles into a single, 24-bit word that can execute in a single instruction cycle.
- The syntax is a superset ADSP-2100 Family assembly language and is completely source and object code compatible with other family members. Programs may need to be relocated to utilize on-chip memory and conform to the ADSP-2185M's interrupt vector and reset vector map.
- Sixteen condition codes are available. For conditional jump, call, return, or arithmetic instructions, the condition can be checked and the operation executed in the same instruction cycle.
- Multifunction instructions allow parallel execution of an arithmetic instruction with up to two fetches or one write to processor memory space during a single instruction cycle.

DESIGNING AN EZ-ICE-COMPATIBLE SYSTEM
The ADSP-2185M has on-chip emulation support and an ICE-Port, a special set of pins that interface to the EZ-ICE. These features allow in-circuit emulation without replacing the target system processor by using only a 14-pin connection from the target system to the EZ-ICE. Target systems must have a 14-pin connector to accept the EZ-ICE's in-circuit probe, a 14-pin plug.

Issuing the chip reset command during emulation causes the DSP to perform a full chip reset, including a reset of its memory mode. Therefore, it is vital that the mode pins are set correctly PRIOR to issuing a chip reset command from the emulator user interface. If a passive method of maintaining mode information is being used (as discussed in Setting Memory Modes), it does not matter that the mode information is latched by an emulator reset. However, if the $\overline{RESET}$ pin is being used as a method of setting the value of the mode pins, the effects of an emulator reset must be taken into consideration.

One method of ensuring that the values located on the mode pins are those desired is to construct a circuit like the one shown in Figure 12. This circuit forces the value located on the Mode A pin to logic high; regardless of whether it is latched via the $\overline{RESET}$ or $\overline{ERESET}$ pin.

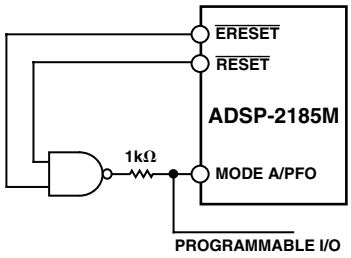


Figure 12. Mode A Pin/EZ-ICE Circuit

See the ADSP-2100 Family EZ-Tools data sheet for complete information on ICE products.

The ICE-Port interface consists of the following ADSP-2185M pins: $\overline{\text{EBR}}$, $\overline{\text{EINT}}$, EE, $\overline{\text{EBG}}$, ECLK, $\overline{\text{ERESET}}$, ELIN, $\overline{\text{EMS}}$, and ELOUT

These ADSP-2185M pins must be connected only to the EZ-ICE connector in the target system. These pins have no function except during emulation, and do not require pull-up or pull-down resistors. The traces for these signals between the ADSP-2185M and the connector must be kept as short as possible, no longer than 3 inches.

The following pins are also used by the EZ-ICE: $\overline{\text{BR}}$, $\overline{\text{BG}}$, $\overline{\text{RESET}}$, and GND.

The EZ-ICE uses the EE (emulator enable) signal to take control of the ADSP-2185M in the target system. This causes the processor to use its $\overline{\text{ERESET}}$, $\overline{\text{EBR}}$, and $\overline{\text{EBG}}$ pins instead of the $\overline{\text{RESET}}$, $\overline{\text{BR}}$, and $\overline{\text{BG}}$ pins. The $\overline{\text{BG}}$ output is three-stated. These signals do not need to be jumper-isolated in your system.

The EZ-ICE connects to your target system via a ribbon cable and a 14-pin female plug. The female plug is plugged onto the 14-pin connector (a pin strip header) on the target board.

Target Board Connector for EZ-ICE Probe
The EZ-ICE connector (a standard pin strip header) is shown in Figure 13. You must add this connector to your target board design if you intend to use the EZ-ICE. Be sure to allow enough room in your system to fit the EZ-ICE probe onto the 14-pin connector.

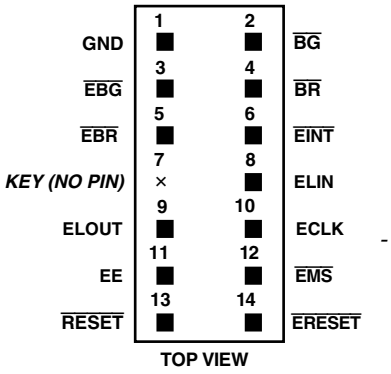


Figure 13. Target Board Connector for EZ-ICE

The 14-pin, 2-row pin strip header is keyed at the Pin 7 location—Pin 7 must be removed from the header. The pins must be 0.025 inch square and at least 0.20 inch in length. Pin spacing should be 0.1 × 0.1 inches. The pin strip header must have at least 0.15 inch clearance on all sides to accept the EZ-ICE probe plug.

Pin strip headers are available from vendors such as 3M, McKenzie, and Samtec.

Target Memory Interface
For your target system to be compatible with the EZ-ICE emulator, it must comply with the memory interface guidelines listed below.

PM, DM, BM, IOM, AND CM
Design your Program Memory (PM), Data Memory (DM), Byte Memory (BM), I/O Memory (IOM), and Composite Memory (CM) external interfaces to comply with worst case device timing requirements and switching characteristics as specified in this data sheet. The performance of the EZ- ICE may approach published worst-case specification for some memory access timing requirements and switching characteristics.

Note: If your target does not meet the worst-case chip specification for memory access parameters, you may not be able to emulate your circuitry at the desired CLKIN frequency. Depending on the severity of the specification violation, you may have trouble manufacturing your system as DSP components statistically vary in switching characteristic and timing requirements within published limits.

Restriction: All memory strobe signals on the ADSP-2185M ($\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{CMS}}$, and $\overline{\text{IOMS}}$) used in your target system must have 10 kΩ pull-up resistors connected when the EZ-ICE is being used. The pull-up resistors are necessary because there are no internal pull-ups to guarantee their state during prolonged three-state conditions resulting from typical EZ-ICE debugging sessions. These resistors may be removed at your option when the EZ-ICE is not being used.

Target System Interface Signals
When the EZ-ICE board is installed, the performance on some system signals change. Design your system to be compatible with the following system interface signal changes introduced by the EZ-ICE board:

- EZ-ICE emulation introduces an 8 ns propagation delay between your target circuitry and the DSP on the $\overline{\text{RESET}}$ signal.
- EZ-ICE emulation introduces an 8 ns propagation delay between your target circuitry and the DSP on the $\overline{\text{BR}}$ signal.
- EZ-ICE emulation ignores $\overline{\text{RESET}}$ and $\overline{\text{BR}}$ when single-stepping.
- EZ-ICE emulation ignores $\overline{\text{RESET}}$ and $\overline{\text{BR}}$ when in Emulator Space (DSP halted).
- EZ-ICE emulation ignores the state of target $\overline{\text{BR}}$ in certain modes. As a result, the target system may take control of the DSP's external memory bus only if bus grant ($\overline{\text{BG}}$) is asserted by the EZ- ICE board's DSP.

FREQUENCY DEPENDENCY FOR TIMING SPECIFICATIONS

t_{CK} is defined as 0.5 t_{CKI}. The ADSP-2185M uses an input clock with a frequency equal to half the instruction rate. For example, a 37.50 MHz input clock (which is equivalent to 26.6 ns) yields a 13.3 ns processor cycle (equivalent to 75 MHz). t_{CK} values within the range of 0.5 t_{CKI} period should be substituted for all relevant timing parameters to obtain the specification value.

Example: t_{CKH} = 0.5 t_{CK} – 2 ns = 0.5 (15 ns) – 2 ns = 5.5 ns

ENVIRONMENTAL CONDITIONS[1]

Rating Description	Symbol	LQFP	Mini-BGA
Thermal Resistance (Case-to-Ambient)	θ_{CA}	48°C/W	63.3°C/W
Thermal Resistance (Junction-to-Ambient)	θ_{JA}	50°C/W	70.7°C/W
Thermal Resistance (Junction-to-Case)	θ_{JC}	2°C/W	7.4°C/W

NOTE
[1]Where the Ambient Temperature Rating (T_{AMB}) is:
$T_{AMB} = T_{CASE} - (PD \times \theta_{CA})$
T_{CASE} = Case Temperature in °C
PD = Power Dissipation in W

POWER DISSIPATION

To determine total power dissipation in a specific application, the following equation should be applied for each output:

$$C \times V_{DD}2 \times f$$

C = load capacitance, f = output switching frequency.

Example:

In an application where external data memory is used and no other outputs are active, power dissipation is calculated as follows:

Assumptions:

- External data memory is accessed every cycle with 50% of the address pins switching.
- External data memory writes occur every other cycle with 50% of the data pins switching.
- Each address and data pin has a 10 pF total load at the pin.
- The application operates at V_{DDEXT} = 3.3 V and t_{CK} = 30 ns.

Total Power Dissipation = $P_{INT} + (C \times V_{DDEXT}^2 \times f)$

P_{INT} = internal power dissipation from Power vs. Frequency graph (Figure 15).

$(C \times V_{DDEXT}^2 \times f)$ is calculated for each output:

Parameters	# of Pins	× C pF	× V_{DDEXT}^2 V	× f MHz	PD mW
Address	7	10	3.3^2	16.67	12.7
Data Output, $\overline{WR}$	9	10	3.3^2	16.67	16.3
$\overline{RD}$	1	10	3.3^2	16.67	1.8
CLKOUT, $\overline{DMS}$	2	10	3.3^2	33.3	7.2
					38.0

Total power dissipation for this example is P_{INT} + 38.0 mW.

Output Drive Currents

Figure 14 shows typical I-V characteristics for the output drivers on the ADSP-2185M. The curves represent the current drive capability of the output drivers as a function of output voltage.

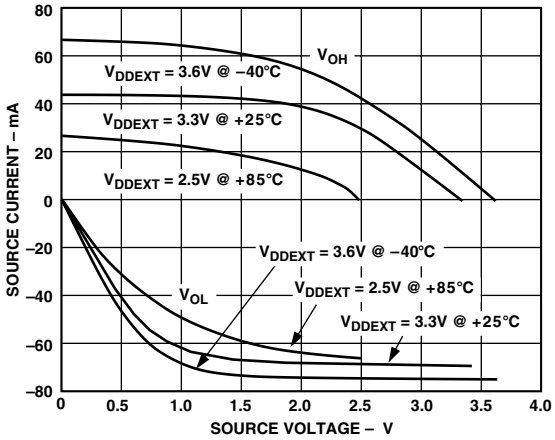


Figure 14. Typical Output Driver Characteristics

Parameter		Min	Max	Unit
Clock Signals and Reset				
Timing Requirements:				
t_{CKI}	CLKIN Period	26.6	80	ns
t_{CKIL}	CLKIN Width Low	8		ns
t_{CKIH}	CLKIN Width High	8		ns
Switching Characteristics:				
t_{CKL}	CLKOUT Width Low	$0.5t_{CK} - 2$		ns
t_{CKH}	CLKOUT Width High	$0.5t_{CK} - 2$		ns
t_{CKOH}	CLKIN High to CLKOUT High	0	13	ns
Control Signals Timing Requirements:				
t_{RSP}	$\overline{\text{RESET}}$ Width Low	$5t_{CK}$[1]		ns
t_{MS}	Mode Setup before $\overline{\text{RESET}}$ High	2		ns
t_{MH}	Mode Hold after $\overline{\text{RESET}}$ High	5		ns

NOTE
[1]Applies after power-up sequence is complete. Internal phase lock loop requires no more than 2000 CLKIN cycles assuming stable CLKIN (not including crystal oscillator start-up time).

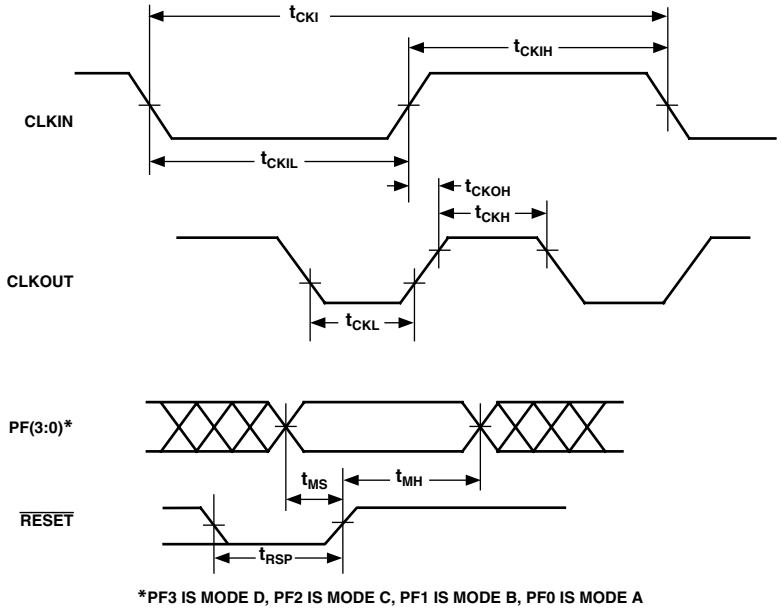


Figure 21. Clock Signals

Parameter		Min	Max	Unit
Bus Request–Bus Grant				
Timing Requirements:				
t_{BH}	$\overline{BR}$ Hold after CLKOUT High[1]	$0.25t_{CK} + 2$		ns
t_{BS}	$\overline{BR}$ Setup before CLKOUT Low[1]	$0.25t_{CK} + 10$		ns
Switching Characteristics:				
t_{SD}	CLKOUT High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable		$0.25t_{CK} + 8$	ns
t_{SDB}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BG}$ Low	0		ns
t_{SE}	$\overline{BG}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable	0		ns
t_{SEC}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable to CLKOUT High	$0.25t_{CK} - 3$		ns
t_{SDBH}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BGH}$ Low[2]	0		ns
t_{SEH}	$\overline{BGH}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable[2]	0		ns

NOTES
$\overline{xMS}$ = $\overline{PMS}$, $\overline{DMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{BMS}$.
[1]$\overline{BR}$ is an asynchronous signal. If $\overline{BR}$ meets the setup/hold requirements, it will be recognized during the current clock cycle; otherwise the signal will be recognized on the following cycle. Refer to the *ADSP-2100 Family User's Manual* for $\overline{BR}$/$\overline{BG}$ cycle relationships.
[2]$\overline{BGH}$ is asserted when the bus is granted and the processor or BDMA requires control of the bus to continue.

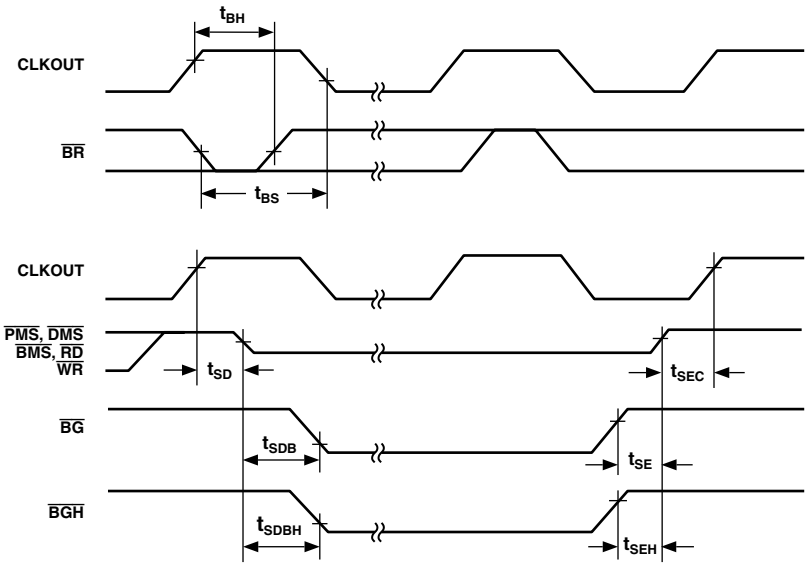


Figure 23. Bus Request–Bus Grant

Parameter		Min	Max	Unit
IDMA Read, Short Read Cycle in Short Read Only Mode[1]				
Timing Requirements:				
t_{IKR}	$\overline{IACK}$ Low before Start of Read[2]	0		ns
t_{IRP}	Duration of Read[3]	10		ns
Switching Characteristics:				
t_{IKHR}	$\overline{IACK}$ High after Start of Read[2]		10	ns
t_{IKDH}	IAD15–0 Previous Data Hold after End of Read[3]	0		ns
t_{IKDD}	IAD15–0 Previous Data Disabled after End of Read[3]		10	ns
t_{IRDE}	IAD15–0 Previous Data Enabled after Start of Read	0		ns
t_{IRDV}	IAD15–0 Previous Data Valid after Start of Read		10	ns

NOTES
[1]Short Read Only is enabled by setting Bit 14 of the IDMA Overlay Register to 1 (0x3FE7). Short Read Only can be enabled by the processor core writing to the register or by an external host writing to the register. Disabled by default.
[2]Start of Read = $\overline{IS}$ Low and $\overline{IRD}$ Low. Previous data remains until end of read.
[3]End of Read = $\overline{IS}$ High or $\overline{IRD}$ High.

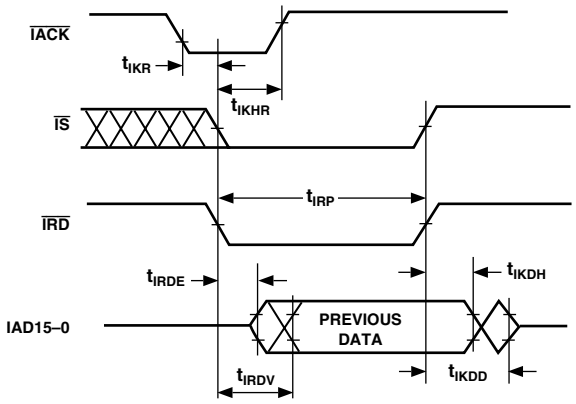
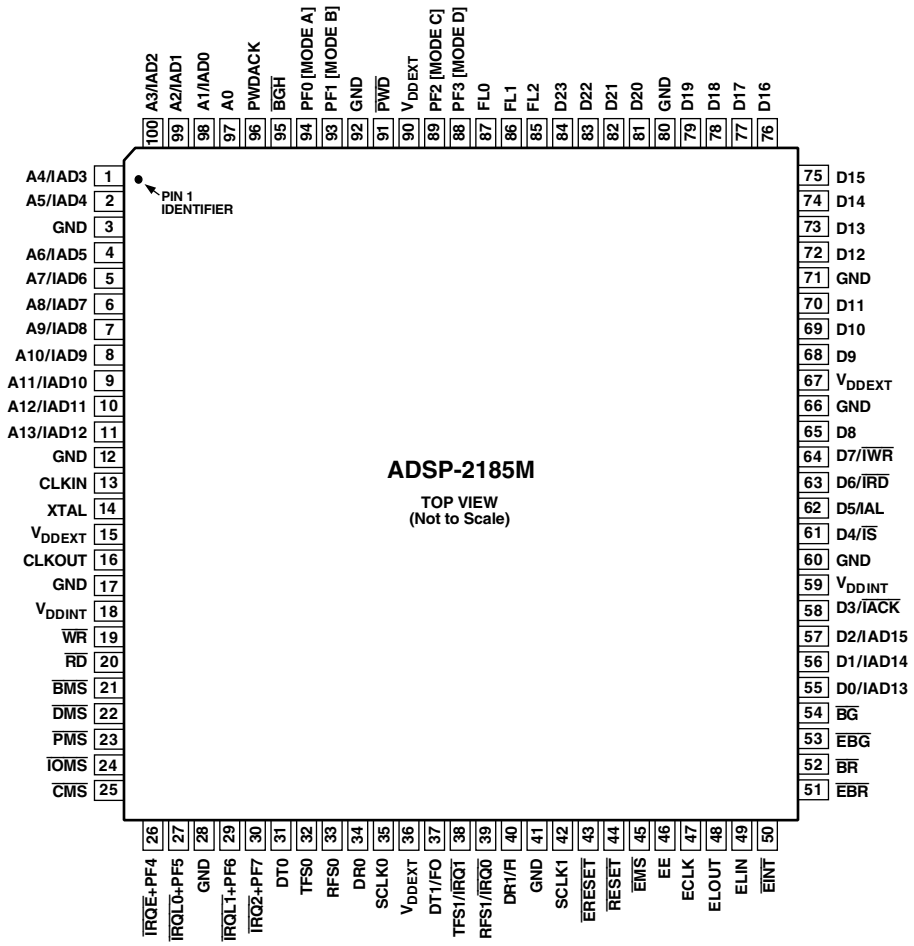


Figure 32. IDMA Read, Short Read Only Cycle

100-LEAD LQFP PIN CONFIGURATION



The LQFP package pinout is shown in the table below. Pin names in bold text replace the plain text named functions when Mode C = 1. A + sign separates two functions when either function can be active for either major I/O mode. Signals enclosed in brackets [ ] are state bits latched from the value of the pin at the deassertion of $\overline{\text{RESET}}$.

The multiplexed pins DT1/FO, TFS1/$\overline{\text{IRQ1}}$, RFS1/$\overline{\text{IRQ0}}$, and DR1/FI, are mode selectable by setting Bit 10 (SPORT1 configure) of the System Control Register. If Bit 10 = 1, these pins have serial port functionality. If Bit 10 = 0, these pins are the external interrupt and flag pins. This bit is set to 1 by default upon reset.

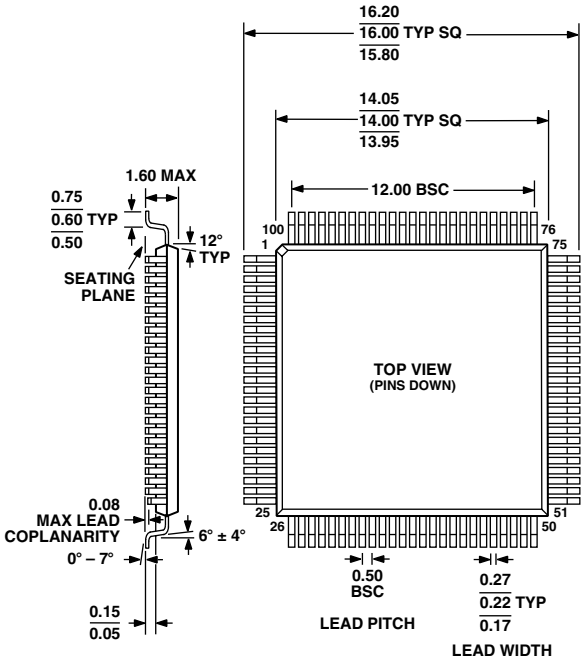
LQFP Package Pinout

Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
1	A4/**IAD3**	26	$\overline{\text{IRQE}}$ + PF4	51	$\overline{\text{EBR}}$	76	D16
2	A5/**IAD4**	27	$\overline{\text{IRQL0}}$ + PF5	52	$\overline{\text{BR}}$	77	D17
3	GND	28	GND	53	$\overline{\text{EBG}}$	78	D18
4	A6/**IAD5**	29	$\overline{\text{IRQL1}}$ + PF6	54	$\overline{\text{BG}}$	79	D19
5	A7/**IAD6**	30	$\overline{\text{IRQ2}}$ + PF7	55	D0/**IAD13**	80	GND
6	A8/**IAD7**	31	DT0	56	D1/**IAD14**	81	D20
7	A9/**IAD8**	32	TFS0	57	D2/**IAD15**	82	D21
8	A10/**IAD9**	33	RFS0	58	D3/$\overline{\textbf{IACK}}$	83	D22
9	A11/**IAD10**	34	DR0	59	V_{DDINT}	84	D23
10	A12/**IAD11**	35	SCLK0	60	GND	85	FL2
11	A13/**IAD12**	36	V_{DDEXT}	61	D4/$\overline{\textbf{IS}}$	86	FL1
12	GND	37	DT1/FO	62	D5/**IAL**	87	FL0
13	CLKIN	38	TFS1/$\overline{\text{IRQ1}}$	63	D6/$\overline{\textbf{IRD}}$	88	PF3 [MODE D]
14	XTAL	39	RFS1/$\overline{\text{IRQ0}}$	64	D7/$\overline{\textbf{IWR}}$	89	PF2 [MODE C]
15	V_{DDEXT}	40	DR1/FI	65	D8	90	V_{DDEXT}
16	CLKOUT	41	GND	66	GND	91	$\overline{\text{PWD}}$
17	GND	42	SCLK1	67	V_{DDEXT}	92	GND
18	V_{DDINT}	43	$\overline{\text{ERESET}}$	68	D9	93	PF1 [MODE B]
19	$\overline{\text{WR}}$	44	$\overline{\text{RESET}}$	69	D10	94	PF0 [MODE A]
20	$\overline{\text{RD}}$	45	$\overline{\text{EMS}}$	70	D11	95	$\overline{\text{BGH}}$
21	$\overline{\text{BMS}}$	46	EE	71	GND	96	PWDACK
22	$\overline{\text{DMS}}$	47	ECLK	72	D12	97	A0
23	$\overline{\text{PMS}}$	48	ELOUT	73	D13	98	A1/**IAD0**
24	$\overline{\text{IOMS}}$	49	ELIN	74	D14	99	A2/**IAD1**
25	$\overline{\text{CMS}}$	50	$\overline{\text{EINT}}$	75	D15	100	A3/**IAD2**

OUTLINE DIMENSIONS

Dimensions shown in millimeters.

100-Lead Metric Thin Plastic Quad Flatpack (LQFP) (ST-100)

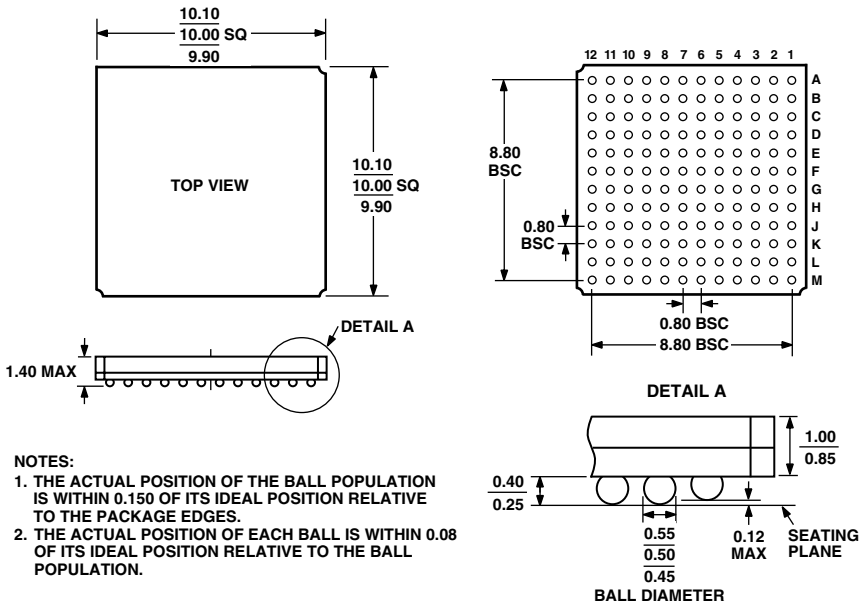


NOTE:
THE ACTUAL POSITION OF EACH LEAD IS WITHIN 0.08 FROM ITS IDEAL POSITION WHEN MEASURED IN THE LATERAL DIRECTION.

OUTLINE DIMENSIONS

Dimensions shown in millimeters.

144-Ball Mini-BGA
(CA-144)



NOTES:
1. THE ACTUAL POSITION OF THE BALL POPULATION IS WITHIN 0.150 OF ITS IDEAL POSITION RELATIVE TO THE PACKAGE EDGES.
2. THE ACTUAL POSITION OF EACH BALL IS WITHIN 0.08 OF ITS IDEAL POSITION RELATIVE TO THE BALL POPULATION.

ORDERING GUIDE

Part Number	Ambient Temperature Range	Instruction Rate	Package Description*	Package Option
ADSP-2185MKST-300	0°C to 70°C	75	100-Lead LQFP	ST-100
ADSP-2185MBST-266	–40°C to +85°C	66	100-Lead LQFP	ST-100
ADSP-2185MKCA-300	0°C to 70°C	75	144-Ball Mini-BGA	CA-144
ADSP-2185MBCA-266	–40°C to +85°C	66	144-Ball Mini-BGA	CA-144

*In 1998, JEDEC reevaluated the specifications for the TQFP package designation, assigning it to packages 1.0 mm thick. Previously labeled TQFP packages (1.6 mm thick) are now designated as LQFP.

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